

______P4-1 由本署塡寫

專利表格第P4號

標準專利 - 請求記錄指定專利申請

《專利條例》(第514章)

《 專 利 (一 般)規 則 》 (第 514C章)

重要須知

- 1. 一般須知:
- a. 中文或英文均可使用為法律程序所採用的語文。除非另有說明,請以中文填寫本表格。
- b. 本表格必須簽署,並註明簽署日期。
- c. 填寫本表格任何部分時,如空位不足,請以附頁書寫。每張附頁須加上頁碼,以及在 11(1) 部分註明附頁的頁數。
- d. 查詢方法如下:
 - 電郵: enquiry@ipd.gov.hk
 - 網址:www.ipd.gov.hk
- 2. 個人資料的使用:
- a. 提供個人資料與否純屬自願,但如果提供的資料不足,專利註冊處可能無法處理你的申請、 提交的要求或通知。
- b. 專利註冊處會將本表格及就本表格提交的任何文件所提供的任何個人資料,用作處理你的申請、要求或通知,以及用於 www.ipd.gov.hk/chi/home.htm 所載的收集目的。 請注意,依據《專利條例》(第 514 章)第 147 條,所提供的資料全部或部分可能會提供予公眾 查閱。 該等資料可透過互聯網查閱。
- c. 專利註冊處在發放可供公眾查閱的資料前,可編輯由你主動提供載於本表格,或就本表格 而提交的任何文件上無明確規定須提交的個人資料。 請勿提供任何無明確規定須提交的 個人資料(包括與第三者有關的個人資料)。
- d. 在符合《專利條例》(第 514 章)的規定下,依據《個人資料(私隱)條例》(第 486 章)第 18 和 22 條,任何人士有權查閱和改正專利註冊處備存的專利紀錄內所載其個人資料。
- e. 詳情請參閱載於 www.ipd.gov.hk/chi/home.htm 的收集個人資料聲明。
- 3. 其他資料的使用:
- 專利註冊處會將本表格及就本表格提交的任何文件所提供有關商業企業或實體的任何資料,用作處理你的申請、要求或通知,以及用於 www.ipd.gov.hk/chi/home.htm 所載的收集目的。 依據《專利條例》(第 514 章)第 147 條,這些資料全部或部分可能會提供予公 眾查閱。 該等資料可透過互聯網查閱。
- b. 請勿提交你認為屬機密或商業敏感的自身或第三者商業資料。 如本表格或就本表格提交的任何文件載有該等資料,註冊處處長將視你和有關的第三者明示及自願同意披露所有該等資料供公眾查閱。
- 4. 遞交申請/請求/通知:

請連同適當的費用,親自或以郵寄方式送交中國香港灣仔皇后大道東 213 號胡忠大廈 24 樓 專利註冊處處長。費用一覽表可於:www.ipd.gov.hk/chi/forms_fees.htm 瀏覽。有關款項 可親自以現金或郵寄支票繳交,支票須註明抬頭人為「香港特別行政區政府」。

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01	來檔編號	

02 申請人資料(如申請人的姓名/名稱並非採用羅馬字母或中文字,請同時以羅馬字母提供姓 名/名稱的音譯。)

中文姓名/名稱

英文姓名/名稱(如適用)

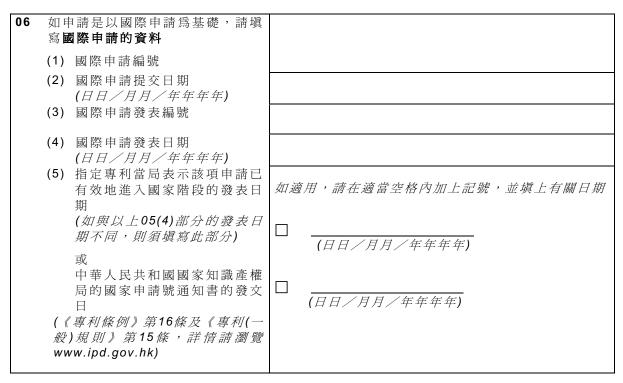
地址

03	申請人是否指定專利申請的申請 人?	<i>請在適當空格內加上記號</i> □ 是 □ 百
	如答「否」,則必須遞交一項解釋 申請人有權就有關發明申請批予標 準專利的 陳述 以及支持該項陳述的 訂明 文件 。 (《專利條例》第15(2)(d)條及《專 利(一般)規則》第9條,詳情請瀏 覽www.ipd.gov.hk)	陳述

註1 發明的名稱必須同時以英文及中文填寫。

04	發明的名稱<i>(註1)</i> 英文	
	中文	

05	指定專利	刂申請的資料	
	(1) 申請	青編號	
		交日期 <i>日/月月/年年年年)</i>	
	(3) 發表	表編號(<i>如有</i>)	
		表日期 <i>(如有)</i> <i>日/月月/年年年年)</i>	



註2 就較早時申請的日期作出聲稱
(1) 如屬分開申請,可根據《專利條例》第22條;
(2) 經在批予後對專利的權利的裁定而按法院命令新提交的申請,則可根據《專利條例》第55條作出聲稱。
《專利條例》可於www.ipd.gov.hk 瀏覽。

07	較早時的申請 如此申請屬分開申請或源自較早時 在香港特別行政區提出的申請,塡 寫較早時的申請的資料(<i>註2</i>)	請在適當空格內加上記號
	(1) 聲稱享有較早時的申請所根 據的條文	《專利條例》 □ □ 第22條 第55條
	(2) 較早時的申請的編號	
	(3) 較早時的申請的提交日期 (日日/月月/年年年年)	
	(4) 較早時的申請的記錄請求的發 表日期 (日日/月月/年年年年)	

08 優先權(請勿提交有關優先權的文件)

如根據《專利條例》第98條**聲稱具有優先權**,請按照《專利條例》第15(2)(e)條的規定, 提供一項**陳述**及**有關細節**。《專利條例》可於www.ipd.gov.hk 瀏覽。

 陳述		
國家/地區/地方	優先權申請編號	優先權申請提交日期
		(日日/月月/年年年年)

09 發明人的姓名/名稱(如發明人的姓名/名稱並非採用羅馬字母或中文字,請同時以羅馬字母提供姓名/名稱的音譯。) 如指定專利申請並無載有任何作為發明人的姓名/名稱,請提供一項識別申請人所相信是發明人的人或人等的陳述。 (《專利條例》第15(2)(b)條,詳情請瀏覽www.ipd.gov.hk)

陳述

中文姓名/名稱	英文姓名/名稱(如適用)

註3 請參閱《專利條例》第95條關於不具損害性披露的權利要求。《專利條例》可於www.ipd.gov.hk 瀏覽。

10	不具損害性的披露 如提出 不具損害性的披露的權利要 求,請按照《專利條例》第15(2)(f)	陳述	_	
	條和《專利(一般)規則》第10條 的規定,提供一項 陳述 及 有關的訂 明細節。《專利條例》及《專利(一	展覽或會議的 名稱及地點	展覽或會議開始日期 (日日/月月/ 年年年年)	首次披露日期 (日日/月月/ 年年年年)
	般)規則》可於www.ipd.gov.hk 瀏 覽。 <i>(註3)</i>			

11 如携	交本表格時附連下列文件,請	
	[文本衣格時前建下列文件/ 崩]文件的頁數	
HL 9	M P (H II / I	頁 數
(1)	隨本表格夾附的附頁	
(2)	已發表的指定專利申請的副本	
(3)	有關國際申請的副本 —	
	● 由國際局所發表的國際申 請	
	 由指定專利當局所發表的 國際申請的譯本 	
	 由指定專利當局所發表關於國際申請的資料 	
(4)	撮錄的譯本	
(5)	解釋申請人有權就有關發明 申請批予標準專利的陳述以 及支持該項陳述的訂明文件	
(6)	其他(<i>請註明</i>)	

註4 你必須提供在中國香港的送達地址。

12	在中國香港的送達地址 <i>(註4)</i>	
	姓名/名稱	
	地址	
	電話號碼	
	傳真號碼	
	電郵地址	

註5 如你是代理人,你必須提供在中國香港的居住地址或進行業務活動的地址。

-		
13	代理人地址 <i>(註5</i>)	
L		

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14 簽署

我/我們確認已閱讀及明白第一頁"重要須知"的內容。

簽署

簽署人姓名及職銜

日期(日日/月月/年年年年)

P4-1 For Official Use



Patents Form P4

Request to record a designated patent application

for a standard patent

Patents Ordinance (Cap. 514)

Patents (General) Rules (Cap. 514C)

Important notes

1. General notes:

- Either Chinese or English can be used as the language of proceedings. Please complete this form in English a. unless otherwise stated.
- b. This form must be signed and dated.
- If there is not enough space for any part on this form, please continue on an additional sheet. Number each c. additional sheet and state the number of additional sheet(s) in Part 11(a). d.
 - Please enquire through the following means:
 - E-mail: enquiry@ipd.gov.hk
 - Internet homepage address: www.ipd.gov.hk

2. Use of Personal data:

- The provision of your personal data is voluntary. However, the Patents Registry may be unable to handle your a. application, filing request or notice if you do not provide sufficient information.
- b. The Patents Registry will use any personal data provided in this form and any document(s) filed in relation to it for processing your application, request or notice, as well as for the purposes of collection set out at www.ipd.gov.hk/eng/home.htm. Any of the information provided may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.
- The Patents Registry may redact unsolicited personal data included with this form or any document(s) filed in c. relation to it before making them available for public inspection. Please DO NOT provide any personal data (including personal data relating to third parties) which are not specifically required to be submitted.
- Subject to the requirements of the Patents Ordinance, Cap. 514, any person has the right to request access to d and correct his/her personal data held in the patent records maintained by the Patents Registry, pursuant to sections 18 and 22 of the Personal Data (Privacy) Ordinance, Cap. 486.
- For further details, please see the Personal Information Collection Statement at www.ipd.gov.hk/eng/home.htm. e.

3. Use of Other Information:

- The Patents Registry will use any information relating to any commercial enterprise or entity provided in this form a. and any document(s) filed in relation to it for processing your application, request or notice, and for the purposes of collection set out at www.ipd.gov.hk/eng/home.htm. They may be made available for public inspection, in full or in part, pursuant to section 147 of the Patents Ordinance, Cap. 514. Such information may be accessed through the Internet.
- DO NOT include any business information of your own or that of third parties which you consider to be b. confidential or commercially sensitive. Where such information is included in this form or any document(s) filed in relation to it, the Registrar will treat it an express and voluntary consent given by you and any such third party to disclosure of all such information for the purpose of public inspection.

4. Submission of application/request/notice:

In person or by mail with the appropriate fee to the Registrar of Patents, 24/F, Wu Chung House, No. 213 Queen's Road East, Wanchai, Hong Kong, China. The fee schedule can be viewed at www.ipd.gov.hk/eng/forms fees.htm. Payment can be made in person by cash, or by sending a cheque made payable to THE GOVERNMENT OF THE HONG KONG SPECIAL ADMINISTRATIVE REGION.

		P4-2
01	Your reference	

02	Details of applicant (If the name of the applicant is not in Roman letters or in Chinese, please include a transliteration in Roman letters.)
Nam	ne

Name in Chinese (if applicable)

Address

03	Is the applicant the person named as the	
	applicant in the designated patent	Please mark the appropriate box
	application?	
		🗌 Yes 🔄 No
	If you have marked "No", you need to	Statement
	submit a statement explaining the	
	applicant's entitlement to apply for the	
	grant of a standard patent and the	
	prescribed documents supporting the	
	statement.	
	(section 15(2)(d), Patents Ordinance and	
	section 9, Patents (General) Rules,	
	which can be viewed at www.ipd.gov.hk)	
	which can be viewed at www.ipd.gov.irkj	

Note 1 You must state the title of the invention in both English and Chinese.

04	Title of invention (Note 1)	
	English	
	Chinese	

05		ils of designated patent ication	
	(a)	Application no.	
	(b)	Filing date (<i>DD-MM-YYYY</i>)	
	(c)	Publication no. (if any)	
	(d)	Publication date <i>(if any)</i> (<i>DD-MM-YYYY</i>)	
06		ils of international application e designated patent application is d on	
	(a)	International application no.	
	(b)	International filing date (DD-MM-YYY)	
	(c)	International publication no.	
	(d)	International publication date (DD-MM-YYYY)	
	(e)	Date of publication in the designated patent office indicating that the international application has validly entered the national phase	Please mark the appropriate box and enter the date in the space provided if applicable
		(if different from the date of publication in Part 05(d) above)	$\Box \qquad \overline{(DD-MM-YYYY)}$
		or	
		Date of issuance of the National Application Notification by the State Intellectual Property Office, People's Republic of China	$\Box \overline{(DD-MM-YYYY)}$
	secti	ion 16, Patents Ordinance and on 15, Patents (General) Rules, n can be viewed at www.ipd.gov.hk)	

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Note 2 A claim of earlier application date may be made under: (a) section 22, Patents Ordinance for divisional application; (b) section 55, Patents Ordinance for new application filed on court order upon determination of right to patent after grade The Patents Ordinance can be viewed at www.ipd.gov.hk.		
07	Details of earlier application	

from	e application is divided or derived an earlier Hong Kong SAR cation (<i>Note 2</i>)	Please mark the appropriate box
(a)	Section under which an earlier application is claimed	Patents Ordinance
(b)	Earlier application no.	
(c)	Earlier application filing date (DD-MM-YYYY)	
(d)	Publication date of the request to record of the earlier application (DD-MM-YYYY)	

08 Priority (please do not submit the priority document)

Where a claim of priority under section 98, Patents Ordinance is made, please provide a statement and details in accordance with section 15(2)(e), Patents Ordinance which can be viewed at www.ipd.gov.hk.

Country/Territory/Area	Priority application no.	Priority application filing date (DD-MM-YYYY)

09 Name of inventor (If the name of the inventor is not in Roman letters or in Chinese, please include a transliteration in Roman letters.) If the designated patent application does not contain the inventor's name, please provide a statement identifying the person(s) the applicant believes to be the inventor(s). (section 15(2)(b), Patents Ordinance, which can be viewed at www.ipd.gov.hk)

Statement

Statement

Name	Name in Chinese (if applicable)

Note 3 Please refer to section 95, Patents Ordinance for claim of non-prejudicial disclosure. The Patents Ordinance can be viewed at www.ipd.gov.hk.

10	Non-prejudicial disclosure Where a claim of non-prejudicial disclosure is made, please provide a statement and prescribed details in			
	accordance with section 15(2)(f), Patents Ordinance and section 10, Patents (General) Rules respectively which can be viewed at www.ipd.gov.hk. (<i>Note 3</i>)	Name and place of the exhibition or meeting	Opening date of the exhibition or meeting (DD-MM-YYYY)	Date of first disclosure (DD-MM-YYYY)

11	follo	er the no. of sheet(s) for any of the owing documents you are filing this form	No. of sheet(s)
	(a)	Additional sheet(s) attached to this form	
	(b)	Copy of the designated patent application as published	
	(c)	In the case of an international application, copy of :	
		 the international application as published by the International Bureau 	
		(ii) translation of the international application published by the designated patent office	
		(iii) publication of information in the designated patent office concerning the international application	
	(d)	Translation of abstract	
	(e)	Statement explaining the applicant's entitlement to apply and the prescribed documents supporting the statement	
	(f)	Others (please specify)	

Note	lote 4 An address for service in Hong Kong, China must be supplied.		
12	Address for service in Hong Kong, China (Note 4)		
	Name		
	Address		
	Telephone no.		
	Facsimile no.		
	E-mail address		

Note 5 If you are an agent, an address in Hong Kong, China where you reside or carry on your business activities must be supplied.

13	Agent's address (Note 5)	
14	Signature I/We confirm that I/we have read and understood the "Important notes" on page 1.	

Signature

Name and Official Capacity of Signatory

Date (DD-MM-YYYY)